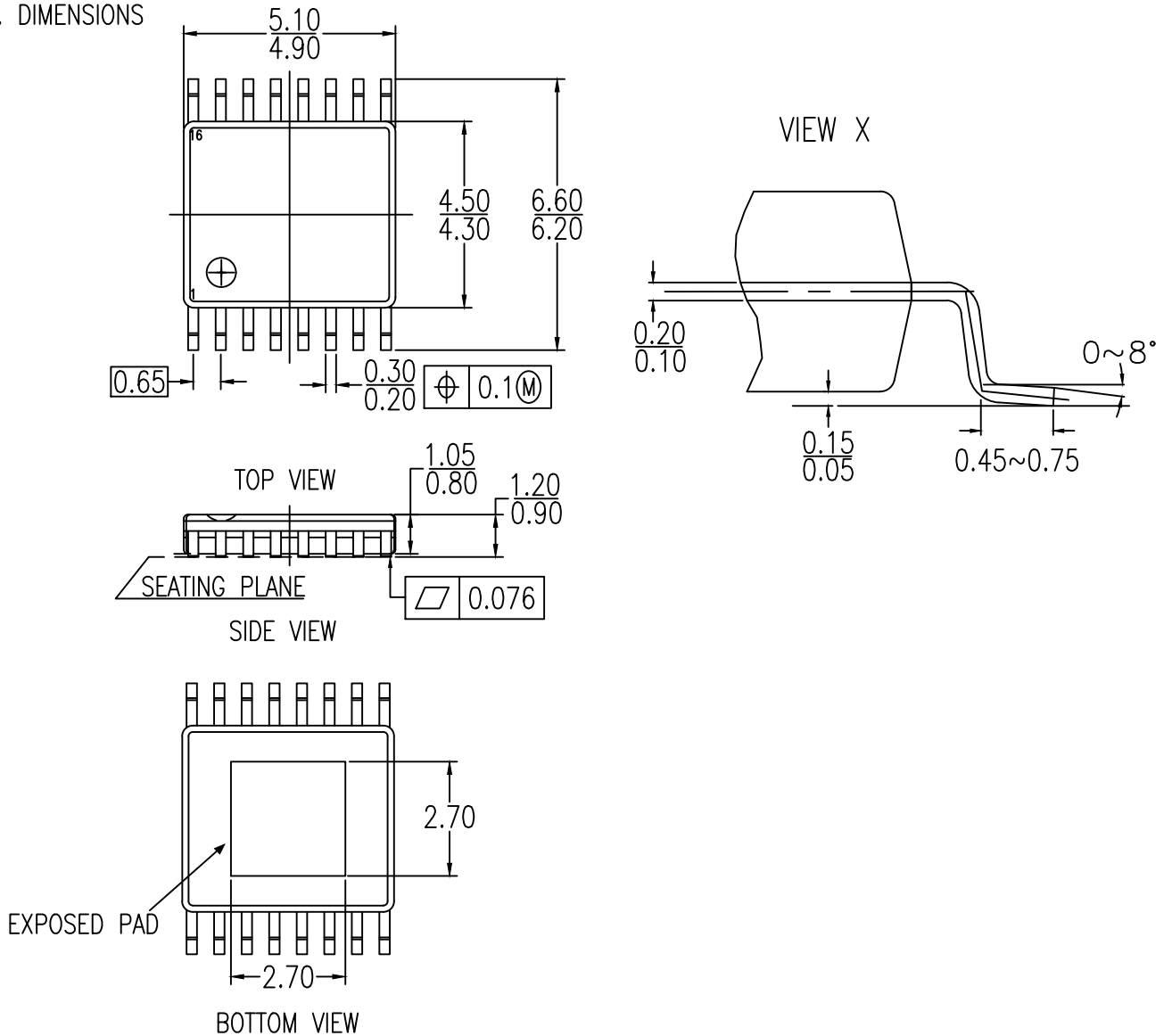


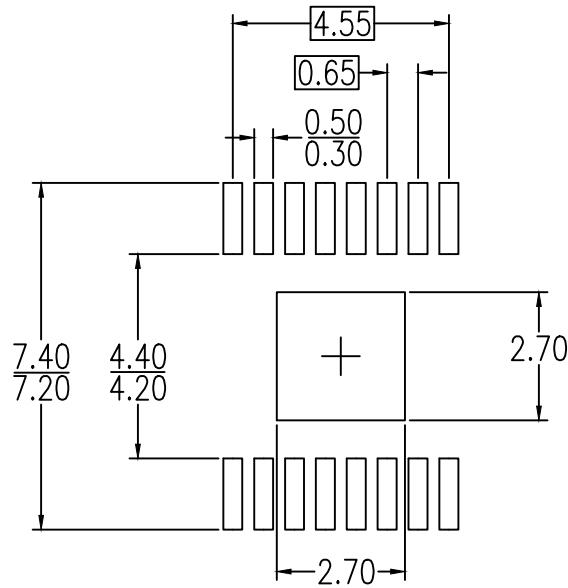
BASED ON JEDEC JEP95: MO-153

1. DIMENSIONS



- 2. WEIGHT ≤ 0.05 g
- 3. BODY MATERIAL LOW STRESS EPOXY
- 4. LEAD MATERIAL Cu-ALLOY
- 5. LEAD FINISH SOLDER PLATING
- 6. LEAD FORM Z-BENDS

* WITHOUT MOLD FLASH
DIMENSIONS IN MILLIMETERS



LAND PATTERN DIMENSIONS

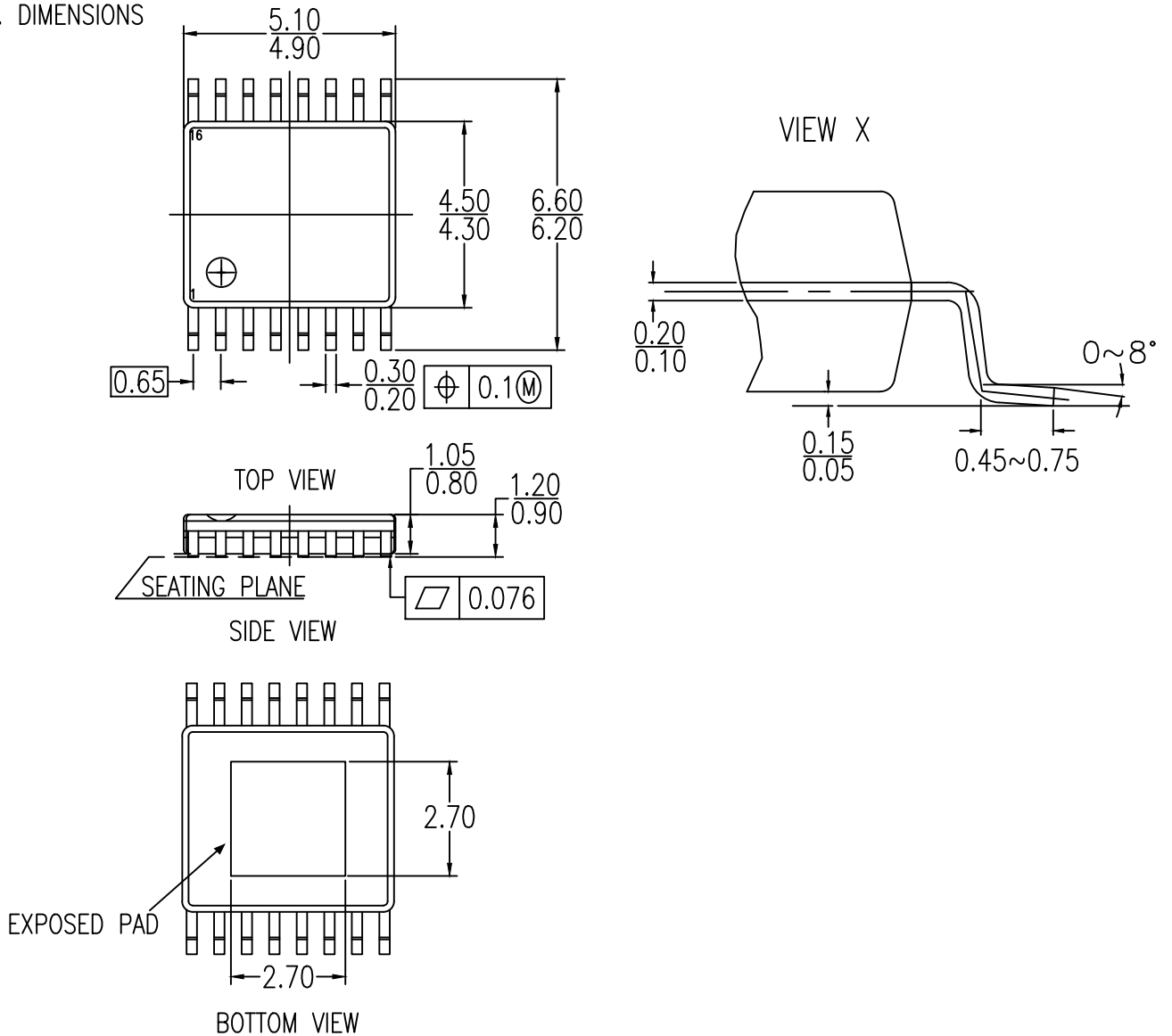
NOTE:

1. ALL DIMENSIONS ARE IN MILLIMETERS

Package Revision History		
Date Created	Rev No.	Description
August 29,2019	Rev 00	Initial Release

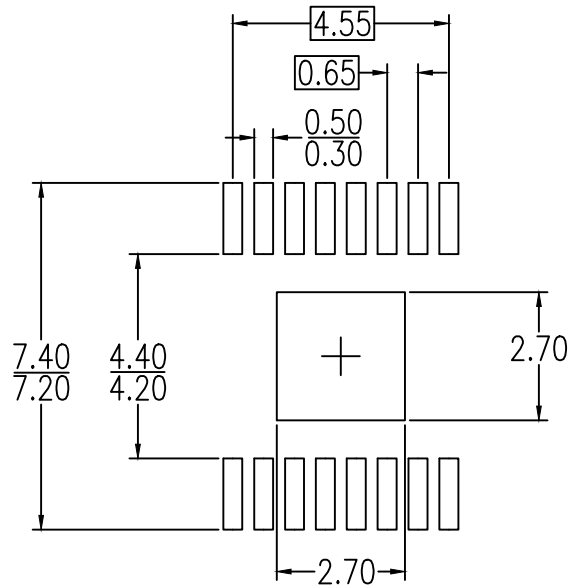
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LAND PATTERN DIMENSIONS

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